

Vishay Siliconix

Dual N-Channel 75-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)		
75	0.048 at V _{GS} = 10 V	4.8		
	0.062 at V _{GS} = 4.5 V	4.2		

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFETs •
- 175 °C Maximum Junction Temperature
- High-Efficiency PWM Optimized ٠
- Compliant to RoHS Directive 2002/95/EC

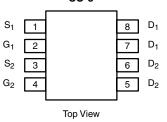


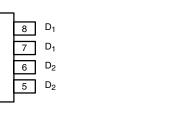
COMPLIANT

HALOGEN

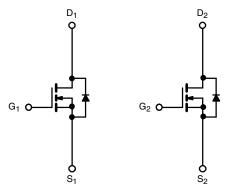
FREE Available

Ordering Information: Si4992EY-T1-E3 (Lead (Pb)-free)





Si4992EY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	Γ _A = 25 °C, unle	ss otherwise r	noted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	75		V
Gate-Source Voltage		V _{GS}	± 20		
	T _A = 25 °C	– I _D	4.8	3.6	
Continuous Drain Current (T _J = 175 °C) ^a	T _A = 85 °C		3.7	2.8	
Continuous Source Current ^a		۱ _S	2	1.1	А
Pulsed Drain Current		I _{DM}	20		
Avalanche Current		I _{AS}	8		
Single Avalanche Energy (Duty Cycle \leq 1 %)	L = 0.1 mH	E _{AS}	3.2		mJ
	T _A = 25 °C	P _D	2.4	1.4	W
Maximum Power Dissipation ^a	T _A = 85 °C	- FD	1.4	0.8	vv
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Mauinum lunation to Ambienta	t ≤ 10 s	R _{thJA}	50	62.5	°C/W
Maximum Junction-to-Ambient ^a	Steady State		85	110	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	31	37	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

SO-8 8 D_1 1 D_1 2 D_2 3 6 D_2 4 5 Top View

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SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min. Ty		Max.	Unit		
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1		3	V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 20 V$			± 100	nA		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 75 V, V_{GS} = 0 V$			1			
		$V_{DS} = 75 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 85 ^{\circ}\text{C}$	Γ _J = 85 °C		20	μA		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	20			Α		
Drain-Source On-State Resistance ^a	Р	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 4.8 \text{ A}$		0.039	0.048	0		
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 4.2 \text{ A}$		0.050	0.062	Ω		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 4.8 \text{ A}$		16		S		
Diode Forward Voltage ^a	V _{SD}	$I_{\rm S} = 2.4$ A, $V_{\rm GS} = 0$ V		0.8	1.2	V		
Dynamic ^b				1				
Total Gate Charge	Qg			14	21	nC		
Gate-Source Charge	Q _{gs}	$V_{DS} = 38$ V, $V_{GS} = 10$ V, $I_{D} = 4.8$ A		2.4				
Gate-Drain Charge	Q _{gd}			3.5				
Gate Resistance	R _g	f = 1 MHz		3.6		Ω		
Turn-On Delay Time	t _{d(on)}			7	15			
Rise Time	t _r	V_{DD} = 38 V, R_L = 38 Ω		10	15	ns		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong \text{1}$ A, V_GEN = 10 V, R_g = 6 Ω		22	35			
Fall Time	t _f			10	15			
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.4 A, dI/dt = 100 A/µs		25	50			

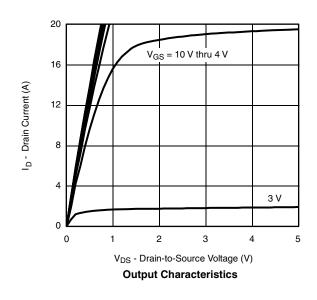
Notes:

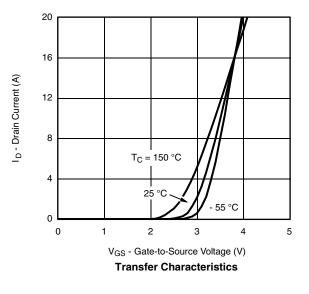
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



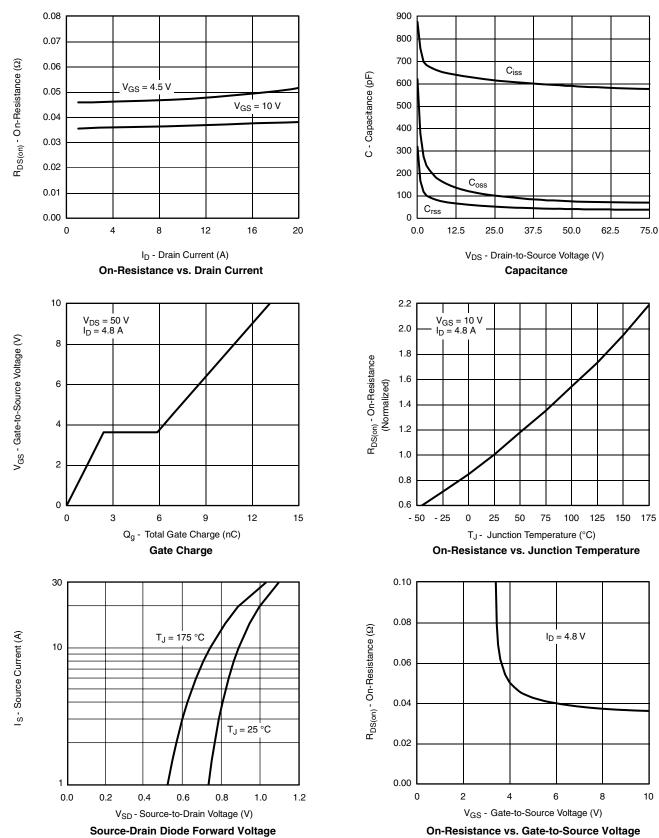




Si4992EY

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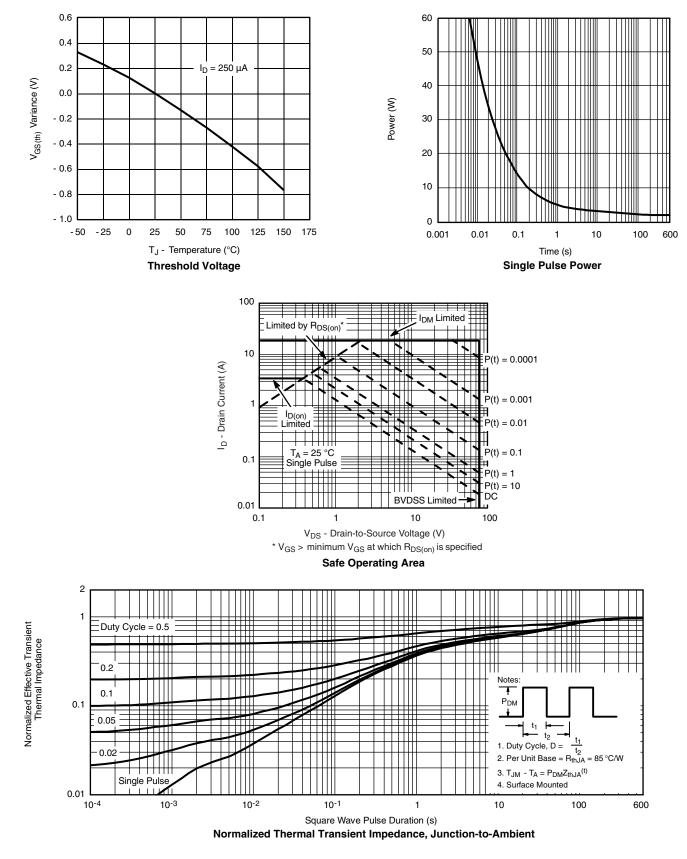
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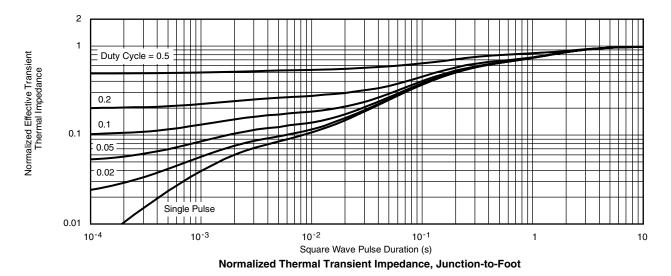
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Si4992EY Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg773082.



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